



**Photocoupler**  
**Product Data Sheet**  
LTV-354T

Spec No. :DS70-2001-004  
Effective Date: 06/16/2017  
Revision: M

**LITE-ON DCC**

**RELEASE**

**BNS-OD-FC001/A4**

## Photocoupler LTV-354T series

### 1. DESCRIPTION

#### 1.1 Features

- AC input response
- Current transfer ratio ( CTR : MIN. 20% at  $I_F = \pm 1\text{mA}$ ,  $V_{CE} = 5\text{V}$  )
- High input-output isolation voltage (  $V_{iso} = 3,750\text{Vrms}$  )
- Mini-flat package : 2.0mm profile : LTV-354T series
- Safety approval
  - UL 1577 & cUL
  - VDE DIN EN60747-5-5 (VDE 0884-5) ,
  - CSA CA5A
  - CQC GB4943.1-2011/ GB8898-2011
  - FIMKO/DEMKO/SEMKO/NEMKO
- RoHS Compliance
  - All materials be used in device are followed EU RoHS directive (No.2002/95/EC).
- ESD pass HBM 8000V/ MM2000V /CDM2000V
- MSL class1

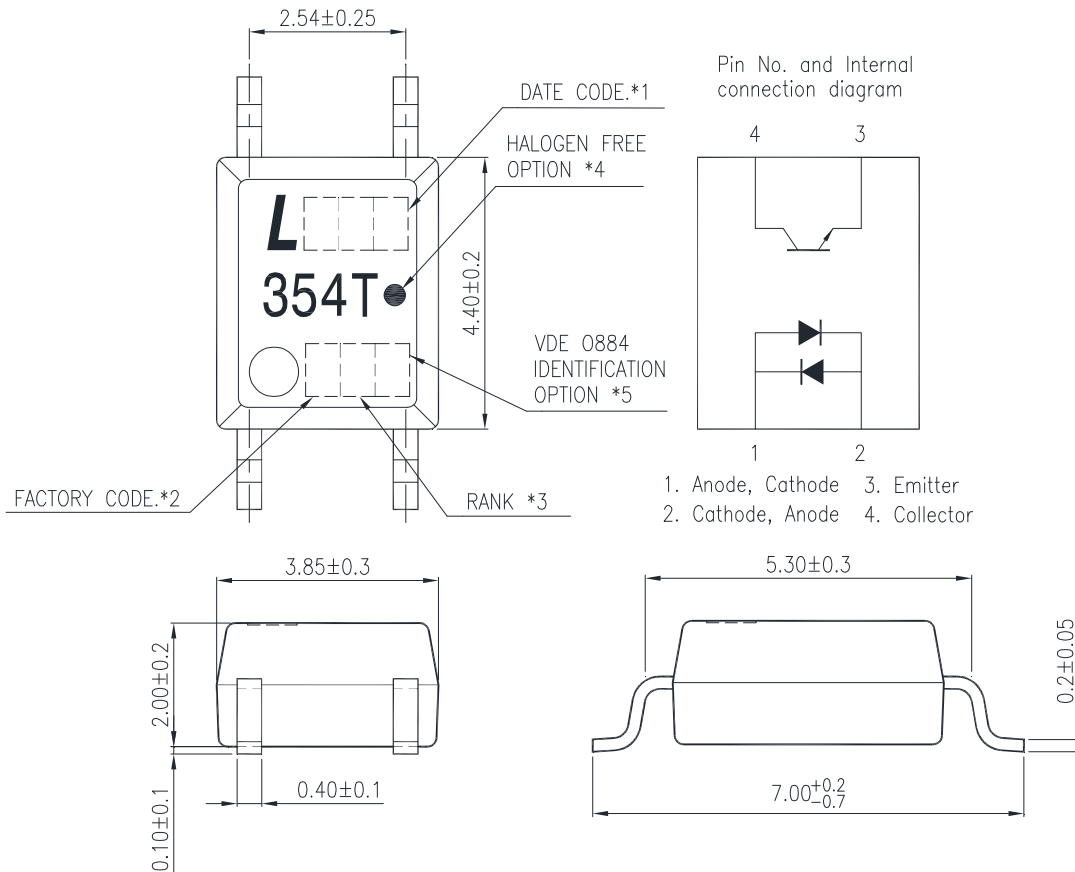
#### 1.2 Applications

- Hybrid substrates that require high density mounting.
- Programmable controllers
- System appliance, measuring instruments

## Photocoupler LTV-354T series

### 2. PACKAGE DIMENSIONS

#### 2.1 LTV-354T series



#### Notes :

- 1-digit year code, Example : 2010 = A  
2-digit work week ranging from '01' to '53'
- Factory identification mark shall be marked (W: China -CZ, X: China -TJ)
- Rank shall be or shall not be marked.
- “●” indicates halogen free option.
- “4”or“V” for VDE option.

\*All dimensions in millimeters.

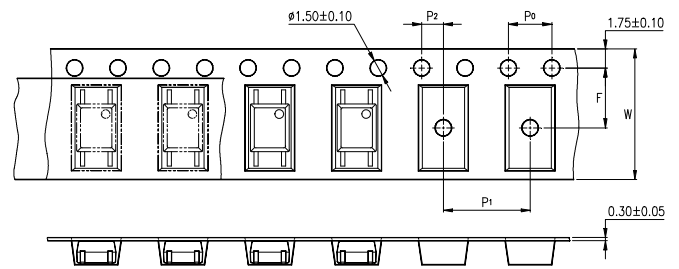
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### 3. TAPING DIMENSIONS

#### 3.1 LTV-354T-TP



#### 3.2 LTV-354T



Description	Symbol	Dimension in mm (inch)
Tape wide	W	12±0.3 (0.472)
Pitch of sprocket holes	P <sub>0</sub>	4±0.1 (0.157)
Distance of compartment	F	5.5±0.1 (0.217)
	P <sub>2</sub>	2±0.1 (0.079)
Distance of compartment to compartment	P <sub>1</sub>	8±0.1 (0.315)

#### 3.3 Quantities Per Reel

Package Type	LTV-354T series
Quantities (pcs)	3000

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### 4. RATING AND CHARACTERISTICS

#### 4.1 Absolute Maximum Ratings at Ta=25°C

	Parameter	Symbol	Rating	Unit
Input	Forward Current	$I_F$	±50	mA
	Power Dissipation	P	70	mW
	Junction Temperature	$T_J$	125	°C
Output	Collector - Emitter Voltage	$V_{CEO}$	35	V
	Emitter - Collector Voltage	$V_{ECO}$	6	V
	Collector Current	$I_C$	50	mA
	Collector Power Dissipation	$P_C$	150	mW
	Junction Temperature	$T_J$	125	°C
	Total Power Dissipation	$P_{tot}$	170	mW
1.	Isolation Voltage	$V_{iso}$	3750	$V_{rms}$
	Operating Temperature	$T_{opr}$	-55 ~ +110	°C
	Storage Temperature	$T_{stg}$	-55 ~ +150	°C
2.	Soldering Temperature	$T_{sol}$	260	°C

1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

2. For 10 Seconds

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### 4.2 ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

	Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Input	Forward Voltage	$V_F$	—	1.2	1.4	V	$I_F = \pm 20\text{mA}$
	Terminal Capacitance	$C_t$	—	30	250	pF	$V=0, f=1\text{KHz}$
Output	Collector Dark Current	$I_{CEO}$	—	—	100	nA	$V_{CE}=20\text{V}, I_F=0$
	Collector-Emitter Breakdown Voltage	$BV_{CEO}$	35	—	—	V	$I_C=0.1\text{mA}, I_F=0$
	Emitter-Collector Breakdown Voltage	$BV_{ECO}$	6	—	—	V	$I_E=10\mu\text{A}, I_F=0$
	Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	0.1	0.2	V	$I_F = \pm 20\text{mA}$ $I_C=1\text{mA}$
	Isolation Resistance	$R_{iso}$	$5 \times 10^{10}$	$1 \times 10^{11}$	—	$\Omega$	DC500V, 40 ~ 60% R.H.
	Floating Capacitance	$C_f$	—	0.6	1	pF	$V=0, f=1\text{MHz}$
	Response Time (Rise)	$t_r$	—	4	18	$\mu\text{s}$	$V_{CE}=2\text{V}, I_C=2\text{mA}$ $R_L=100\Omega,$
	Response Time (Fall)	$t_f$	—	3	18	$\mu\text{s}$	

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### 5. RANK TABLE OF CURRENT TRANSFER RATIO (CTR)

CTR Rank	Min	Max	Condition
GR	100	300	$I_F = \pm 5\text{mA}$ , $V_{CE} = 5\text{V}$ , $T_a = 25^\circ\text{C}$
A	50	150	$I_F = \pm 1\text{mA}$ , $V_{CE} = 5\text{V}$ , $T_a = 25^\circ\text{C}$
B	80	400	
B2	100	400	
C	200	400	
No mark	20	400	

$$\text{CTR} = \frac{I_C}{I_F} \times 100\%$$

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## 6. CHARACTERISTICS CURVES (TYPICAL PERFORMANCE)

Fig.1 Forward Current vs. Ambient Temperature

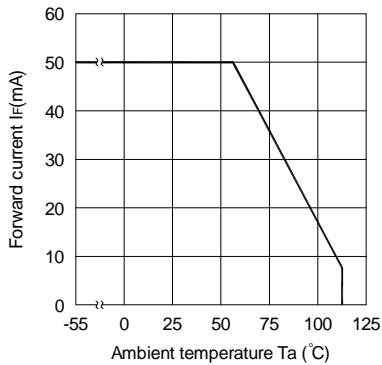


Fig.2 Collector Power Dissipation vs. Ambient Temperature

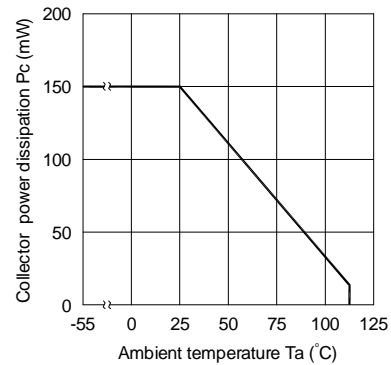


Fig.3 Collector-emitter Saturation Voltage vs. Forward Current

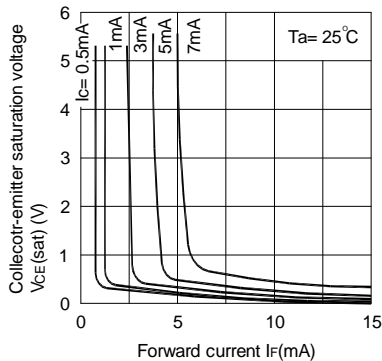


Fig.4 Forward Current vs. Forward Voltage

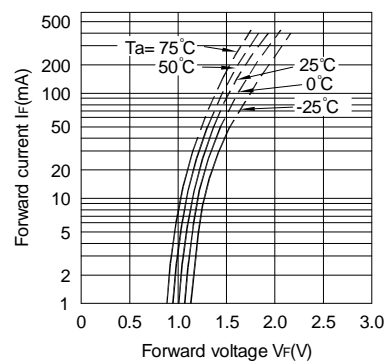


Fig.5 Current Transfer Ratio vs. Forward Current

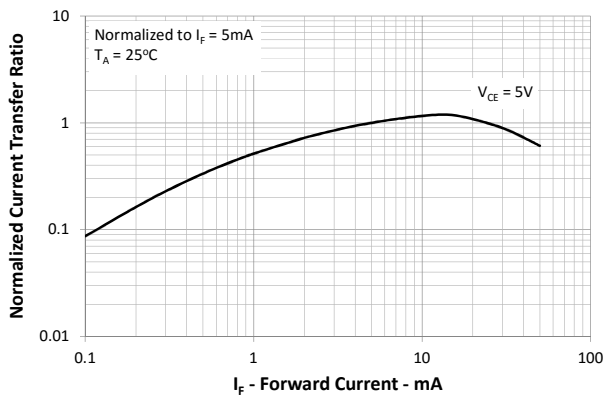
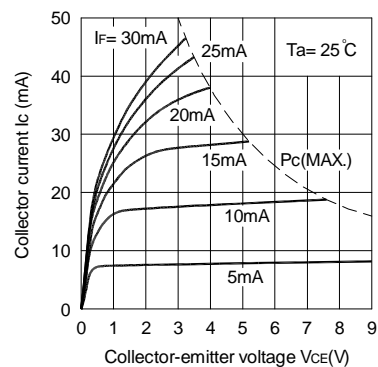


Fig.6 Collector Current vs. Collector-emitter Voltage





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Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

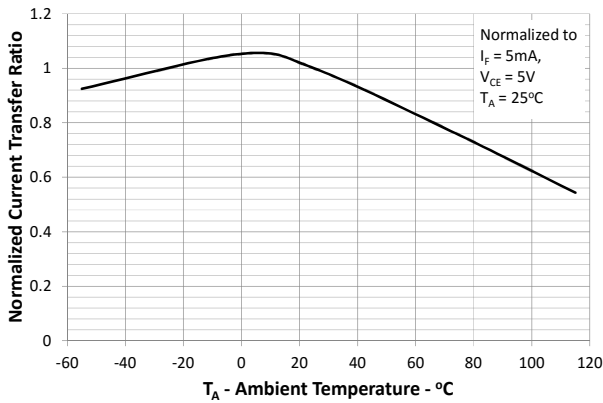


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

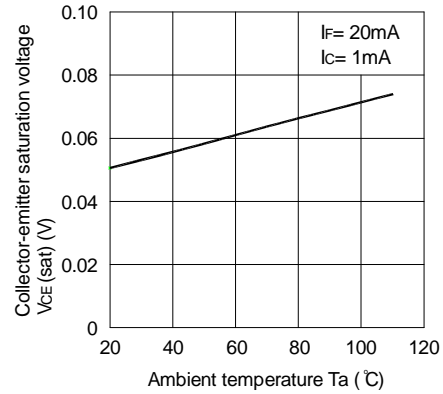


Fig.9 Collector Dark Current vs. Ambient Temperature

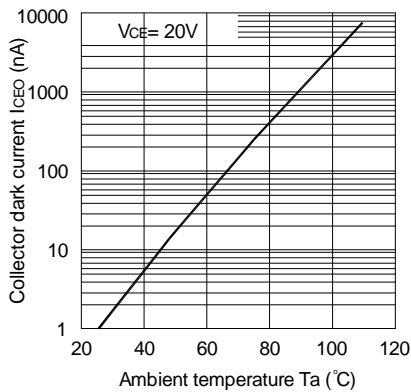


Fig.10 Response Time vs. Load Resistance

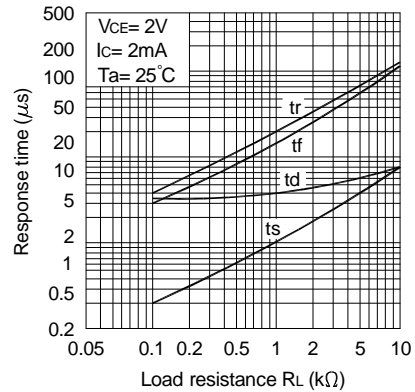
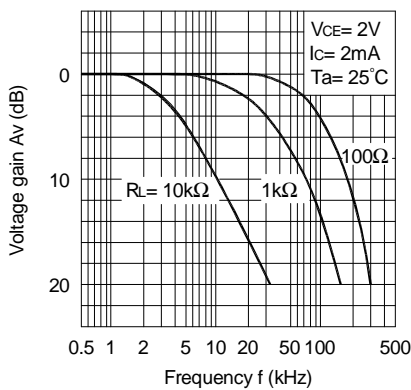
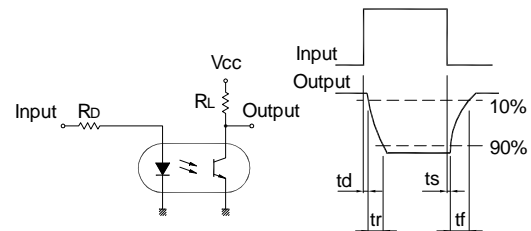


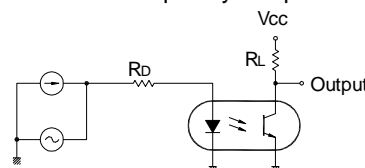
Fig.11 Frequency Response



Test Circuit for Response Time



Test Circuit for Frequency Response



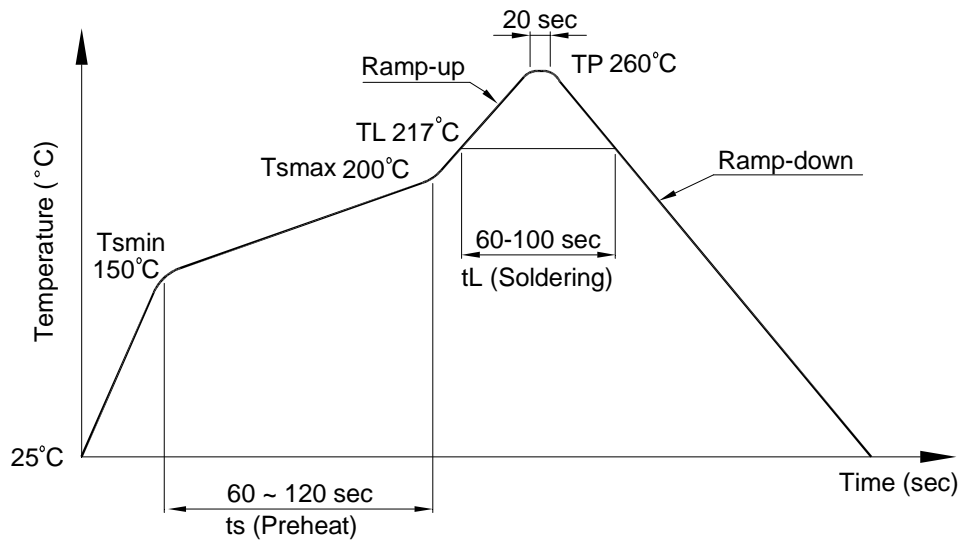
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## 7. TEMPERATURE PROFILE OF SOLDERING

### 7.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

Profile item	Conditions
Preheat	
- Temperature Min ( $T_{Smin}$ )	150°C
- Temperature Max ( $T_{Smax}$ )	200°C
- Time (min to max) (ts)	90±30 sec
Soldering zone	
- Temperature ( $T_L$ )	217°C
- Time ( $t_L$ )	60 ~ 100 sec
Peak Temperature ( $T_P$ )	260°C
Ramp-up rate	3°C / sec max.
Ramp-down rate	3~6°C / sec



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**7.2 Wave soldering (JEDEC22A111 compliant)**

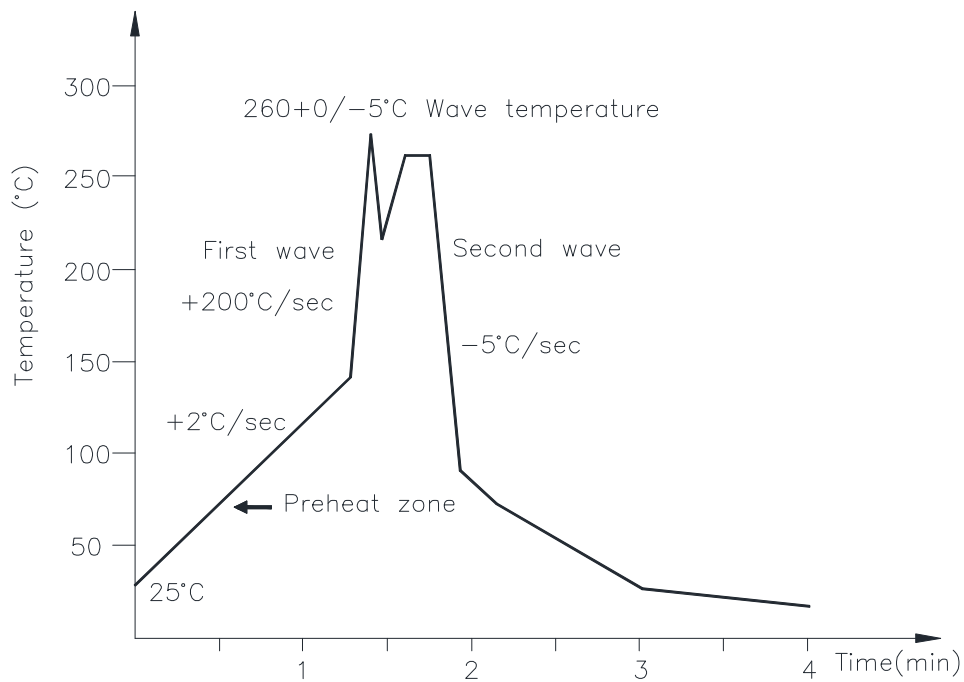
One time soldering is recommended within the condition of temperature.

Temperature:  $260+0/-5^{\circ}\text{C}$

Time: 10 sec.

Preheat temperature: 25 to  $140^{\circ}\text{C}$

Preheat time: 30 to 80 sec.



**7.3 Hand soldering by soldering iron**

Allow single lead soldering in every single process. One time soldering is recommended.

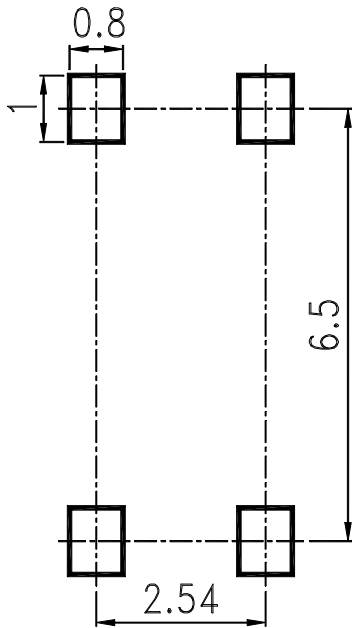
Temperature:  $380+0/-5^{\circ}\text{C}$

Time: 3 sec max.

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**8. RRECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)**

Unit: mm



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**9. NAMING RULE**

**LTV-354T-(1)-(2)-G**

DEVICE PART NUMBER

(1) TAPING TYPE (TP, no suffix)

LTV-354T has tape and reel solution.

Please refer to orientation of taping on Page P3

(2) CTR RANK (A,B or none)

Please refer to Page P6

(3) Halogen free option

Example : LTV-354T-TP-A-G

**LTV 354T (1) (2)-V-G**

DEVICE PART NUMBER

(1) TAPING TYPE (TP, no suffix)

LTV-354T has tape and reel solution.

Please refer to orientation of taping on Page P3

(2) CTR RANK (A,B or none)

Please refer to Page P6

(3) VDE option

(4) Halogen free option

Example : LTV354TTPA-V-G

**10. NOTES**

- LiteOn is continually improving the quality, reliability, function or design and LiteOn reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.